

Excellent Integrated System Limited

Stocking Distributor

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[IXYS Corporation](#)

[MKI80-06T6K](#)

For any questions, you can email us directly:

sales@integrated-circuit.com

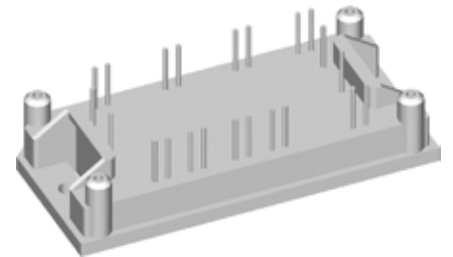
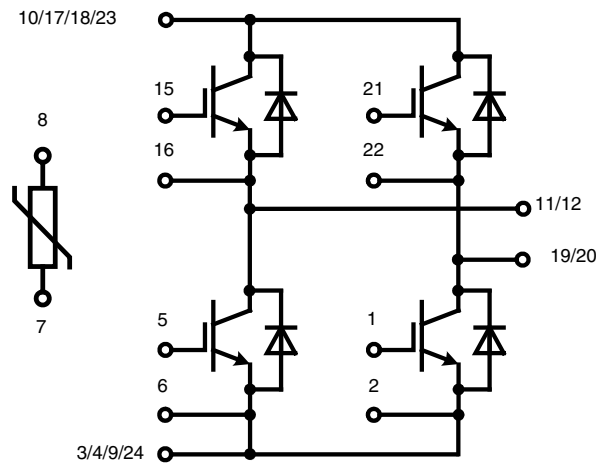
IGBT Modules
H-Bridge
Trench IGBT

$I_{C25} = 89 A$
 $V_{CES} = 600 V$
 $V_{CE(sat) typ.} = 1.8 V$

Preliminary data

Part name (Marking on product)

MKI 80-06T6K



Features:

- Trench IGBT technology
- Low saturation voltage
- Low switching losses
- Square RBSOA, no latch up
- High short circuit capability
- Positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- Ultra fast free wheeling diodes
- Solderable pins for PCB mounting
- Space saving
- Reduced protection circuits

Application:


- AC motor control
- AC servo and robot drives
- Power supplies

Package:

- Industry standard E1-pack
- Designed for wave soldering
- With copper base plate

IGBTs							
Symbol	Definitions	Conditions	Ratings			Unit	
			min.	typ.	max.		
V_{CES}	collector emitter voltage		$T_{VJ} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$			V	
V_{GES}	max. DC gate voltage	continuous			± 20	V	
V_{GEM}	max. transient collector gate voltage	transient			± 30	V	
I_{C25}	collector current		$T_C = 25^{\circ}\text{C}$			A	
I_{C80}			$T_C = 80^{\circ}\text{C}$			A	
P_{tot}	total power dissipation		$T_C = 25^{\circ}\text{C}$			W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 75\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$			1.8	
			$T_{VJ} = 125^{\circ}\text{C}$			2.3	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 1.2\text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^{\circ}\text{C}$			5	
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$			1	
			$T_{VJ} = 125^{\circ}\text{C}$			0.5	
I_{GES}	gate emitter leakage current	$V_{CE} = 0\text{ V}; V_{GE} = \pm 20\text{ V}$			400	nA	
C_{ies}	input capacitance	$V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 1\text{ MHz}$		4620		pF	
$Q_{G(on)}$	total gate charge	$V_{CE} = 480\text{ V}; V_{GE} = 15\text{ V}; I_C = 75\text{ A}$		470		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 300\text{ V}; I_C = 75\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 5.1\ \Omega$	$T_{VJ} = 125^{\circ}\text{C}$			30	ns
t_r	current rise time		20	ns			
$t_{d(off)}$	turn-off delay time		250	ns			
t_f	current fall time		70	ns			
E_{on}	turn-on energy per pulse		2.5	mJ			
E_{off}	turn-off energy per pulse		2.8	mJ			
I_{CM}	reverse bias safe operating area	RBSOA; $V_{GE} = \pm 15\text{ V}; R_G = 5.1\ \Omega; L = 100\ \mu\text{H}$	150			A	
V_{CEK}		clamped inductive load; $T_{VJ} = 125^{\circ}\text{C}$	0.9x	V_{CES}			
t_{SC} (SCSOA)	short circuit safe operating area	$V_{CE} = 480\text{ V}; V_{GE} = \pm 15\text{ V}; R_G = 5.1\ \Omega; \text{non-repetitive}$	$T_{VJ} = 125^{\circ}\text{C}$			6	μs
R_{thJC}	thermal resistance junction to case	(per IGBT)			0.6	K/W	
R_{thCH}	thermal resistance case to heatsink	(per IGBT)	0.2			K/W	

Diodes								
Symbol	Definitions	Conditions	Maximum Ratings			Unit		
			min.	typ.	max.			
V_{RRM}	max. repetitive reverse voltage				600	V		
I_{F25}	forward current		$T_C = 25^{\circ}\text{C}$			105	A	
I_{F80}			$T_C = 80^{\circ}\text{C}$			67	A	
Symbol	Conditions	Characteristic Values				Unit		
		min.	typ.	max.				
V_F	forward voltage	$I_F = 75\text{ A}$	$T_{VJ} = 25^{\circ}\text{C}$			1.8	2.2	V
			$T_{VJ} = 125^{\circ}\text{C}$			1.6		V
I_{RM}	max. reverse recovery current	$V_R = 300\text{ V}; I_F = 75\text{ A}$ $di_F/dt = -600\text{ A}/\mu\text{s}$	$T_{VJ} = 100^{\circ}\text{C}$			36		A
t_{rr}	reverse recovery time		$T_{VJ} = 100^{\circ}\text{C}$	100			ns	
R_{thJC}	thermal resistance junction to case	(per diode)	$T_{VJ} = 25^{\circ}\text{C}$				0.65	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)	0.25				K/W	

	MKI 80-06T6K
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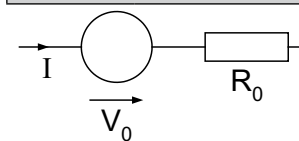
Temperature Sensor NTC

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
R_{25}	resistance	$T_C = 25^{\circ}\text{C}$	4.45	4.7	5.0	k Ω
$B_{25/85}$				3510		K

Module

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
T_{VJ}	operating temperature		-40		125	$^{\circ}\text{C}$
T_{VJM}	max. virtual junction temperature				175	$^{\circ}\text{C}$
T_{stg}	storage temperature		-40		125	$^{\circ}\text{C}$
V_{ISOL}	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
M_d	mounting torque	(M4)	2.0		2.2	Nm
d_s	creep distance on surface		12.7			mm
d_A	strike distance through air		12.7			mm
Weight				40		g

Equivalent Circuits for Simulation

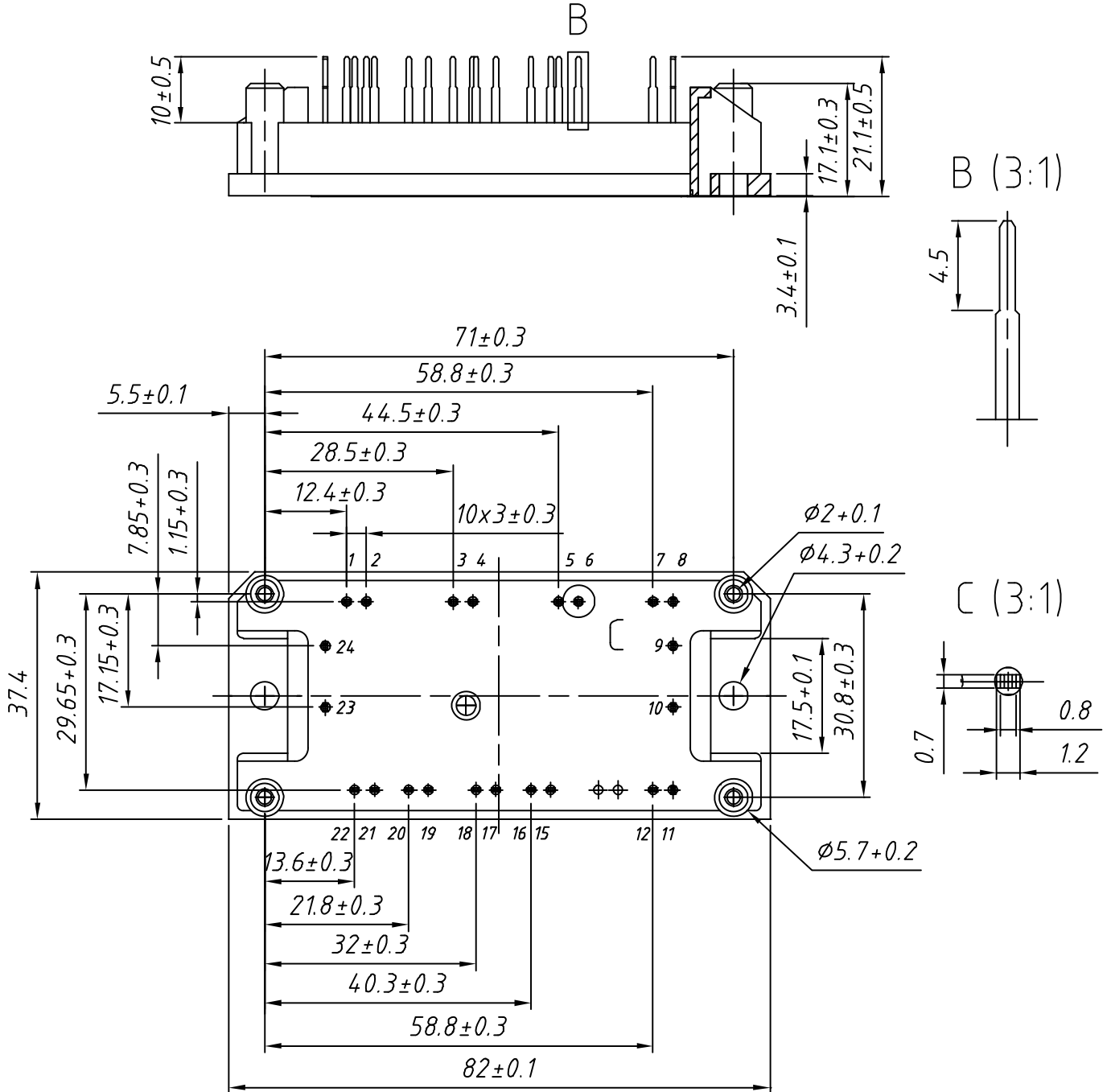


Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_0	IGBT	$T_{VJ} = 125^{\circ}\text{C}$		0.9		V
R_0				14.3		m Ω
V_0	free wheeling diode	$T_{VJ} = 125^{\circ}\text{C}$		1.25		V
R_0				3		m Ω

Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MKI 80-06T6K	MKI80-06T6K	Box	10	504061

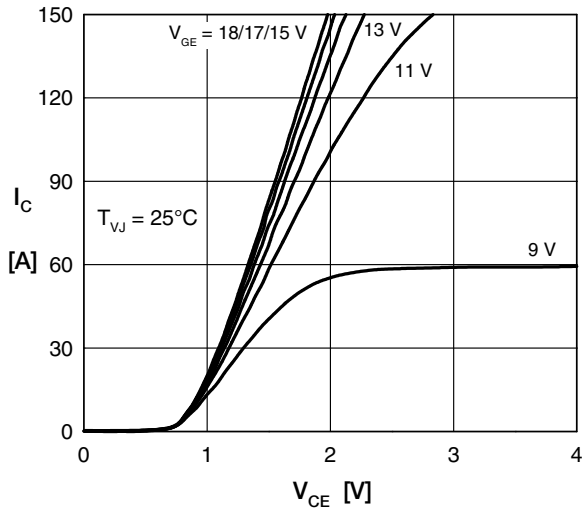


Fig. 1 Typical output characteristics

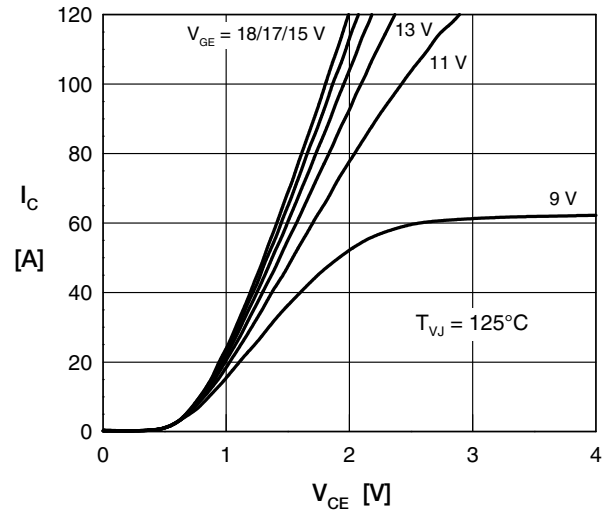


Fig. 2 Typical output characteristics

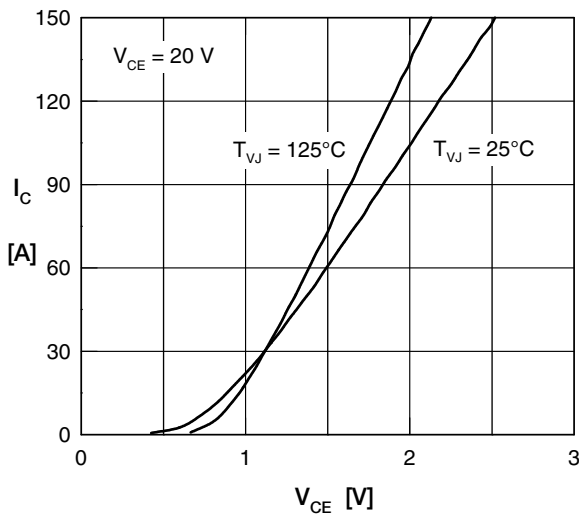


Fig. 3 Typical output characteristics

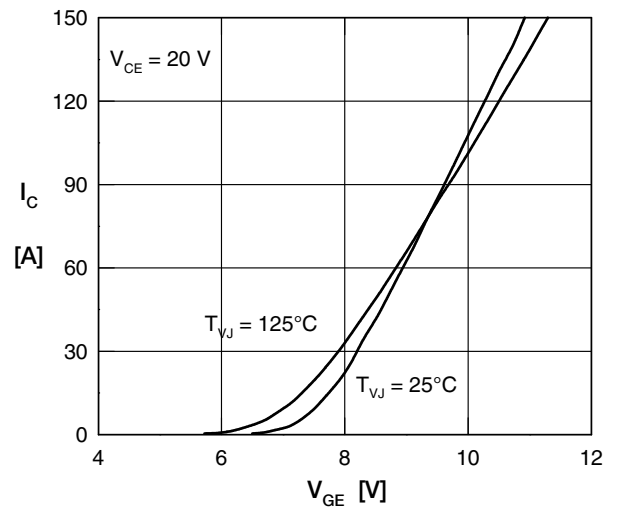


Fig. 4 Typical transfer characteristics

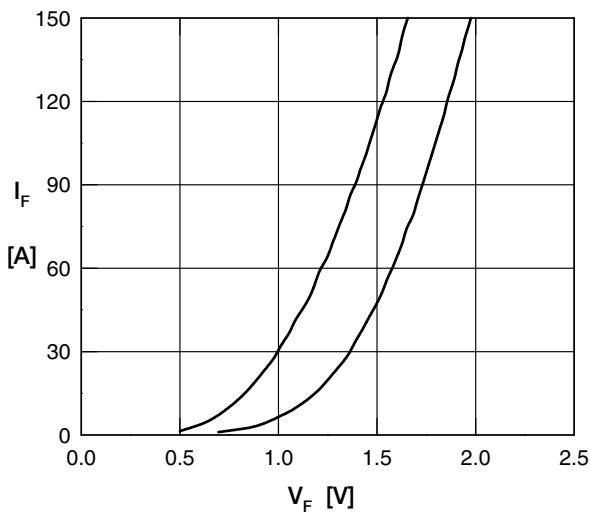


Fig. 5 Typical forward characteristics FWD

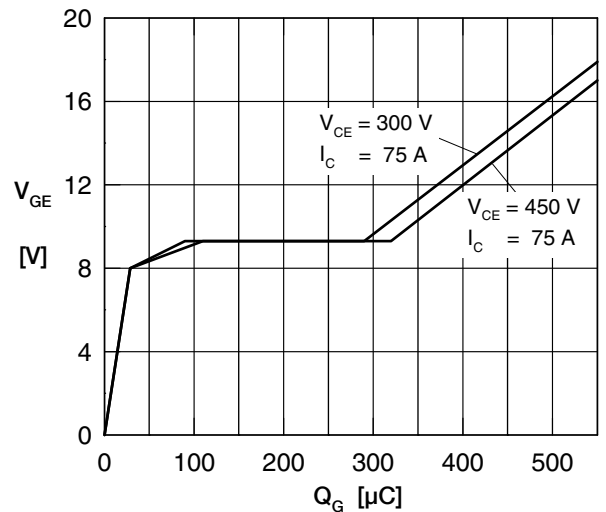


Fig. 6 Typical turn-on gate charge